



AO3416, AO3416L (Green Product) N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO3416 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected. AO3416L (Green Product) is offered in a lead-free package.

Features

 $V_{DS}(V) = 20V$

 $I_D = 6.5 A$

 $R_{DS(ON)}$ < 22m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)}$ < 26m Ω (V_{GS} = 2.5V)

 $R_{DS(ON)}$ < 34m Ω (V_{GS} = 1.8V)

ESD Rating: 2000V HBM



Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	20	V				
Gate-Source Voltage		V_{GS}	±8	V				
Continuous Drain	T _A =25°C		6.5					
Current ^A	T _A =70°C	I_D	5.2	Α				
Pulsed Drain Current ^B		I _{DM}	30					
	T _A =25°C	P _D	1.4	W				
Power Dissipation ^A	T _A =70°C		0.9	VV				
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Typ Max l					
Maximum Junction-to-Ambient A	t ≤ 10s	В	65	90	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	$ R_{\theta JA}$	85	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	43	60	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Тур	Max	Units			
STATIC PARAMETERS									
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V, V _{GS} =0V			1	μА			
		T _J =55°(C		5	μΑ			
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±4.5V			±1	μ A			
		V_{DS} =0V, V_{GS} =±8V			±10	μΑ			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250\mu A$	0.4	0.6	1	V			
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	30			Α			
R _{DS(ON)} Stati	Static Drain-Source On-Resistance	V _{GS} =4.5V, I _D =6.5A		18	22	mΩ			
		T _J =125°	C	25	30	1115.2			
	Static Dialii-Source Off-Nesistance	V_{GS} =2.5V, I_D =5.5A		21	26	mΩ			
		V_{GS} =1.8V, I_D =5A		26	34	mΩ			
g _{FS}	Forward Transconductance	V_{DS} =5V, I_{D} =6.5A		29		S			
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.76	1	V			
I_S	Maximum Body-Diode Continuous Current					Α			
	CPARAMETERS	4,15	710						
C _{iss}	Input Capacitance		10	1160		pF			
C _{oss}	Output Capacitance V _{GS} =0V, V _{DS} =10V, f=11 Reverse Transfer Capacitance			187		pF			
C_{rss}	Reverse Transfer Capacitance			146		pF			
R_g	Gate resistance V _{GS} =0V, V _{DS} =0V, f=1MHz			1.5		Ω			
SWITCHI	NG PARAMETERS	11							
Q_g	Total Gate Charge			16		nC			
Q_{gs}	Gate Source Charge V_{GS} =4.5V, V_{DS} =10V, I_D =6.5A			0.8		nC			
Q_{gd}	Gate Drain Charge			3.8		nC			
t _{D(on)}	Turn-On DelayTime			6.2		ns			
t _r	Turn-On Rise Time	V_{GS} =5V, V_{DS} =10V, R_L =1.5 Ω ,		12.7		ns			
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		51.7		ns			
t _f	Turn-Off Fall Time			16		ns			
t _{rr}	Body Diode Reverse Recovery Time	I _F =6.5A, dI/dt=100A/μs		17.7		ns			
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =6.5A, dI/dt=100A/μs		6.7		nC			

A: The value of $R_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25 °C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

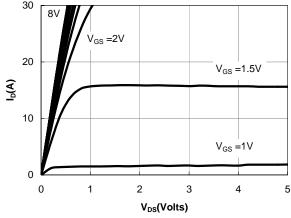


Figure 1: On-Regions CharacteristiCS

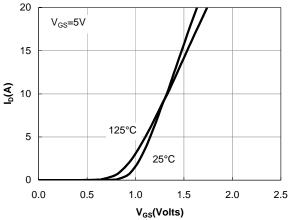


Figure 2: Transfer Characteristics

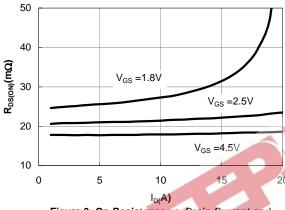


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

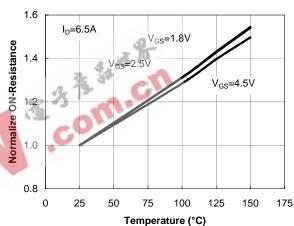


Figure 4: On-Resistance vs. Junction Temperature

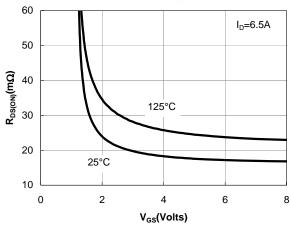


Figure 5: On-Resistance vs. Gate-Source Voltage

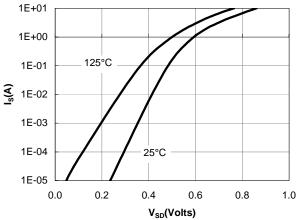
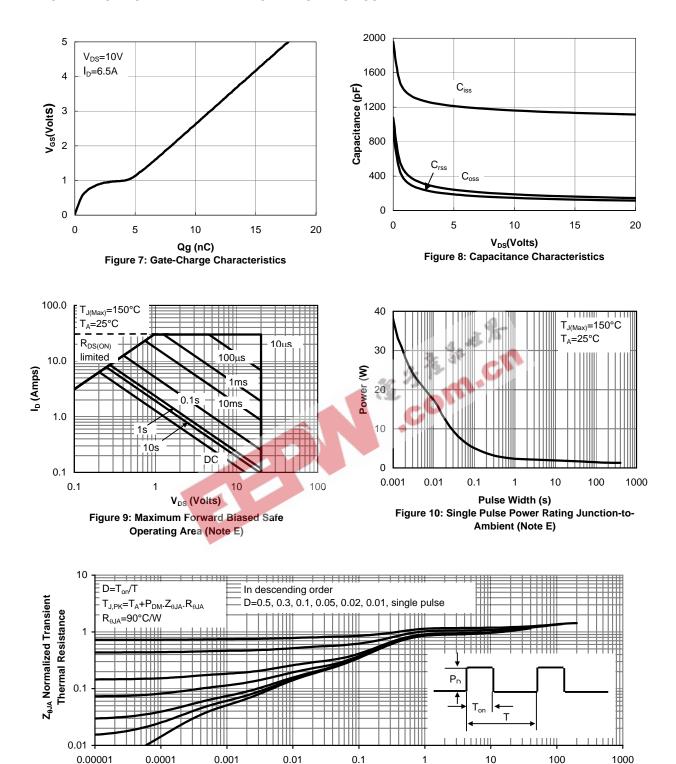


Figure 6: Body-Diode Characteristics

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Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance